

PATENT ASSIGNMENT COVER SHEET

Electronic Version v1.1
Stylesheet Version v1.2

EPAS ID: PAT3778513

SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT
CONVEYING PARTY DATA	
Name	Execution Date
CHI YIN MAK	03/03/2016
RECEIVING PARTY DATA	
Name:	C.M. PRODUCTS LIMITED
Street Address:	5/F, BLOCK A, TUNG SING BUILDING
Internal Address:	138-144 QUEEN'S ROAD EAST
City:	WANCHAI
State/Country:	HONG KONG
PROPERTY NUMBERS Total: 1	
Property Type	Number
Application Number:	14991587
CORRESPONDENCE DATA	
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<i>Correspondence will be sent to the e-mail address first; if that is unsuccessful, it will be sent using a fax number, if provided; if that is unsuccessful, it will be sent via US Mail.</i>	
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ATTORNEY DOCKET NUMBER:	127001-00102
NAME OF SUBMITTER:	NAVEED HASAN
SIGNATURE:	/Naveed Hasan/
DATE SIGNED:	03/10/2016
Total Attachments: 2	
source=127001-00102_Assignment#page1.tif	
source=127001-00102_Assignment#page2.tif	

ASSIGNMENT

I, Chi Yin Mak residing at Hong Kong, China in consideration of One Dollar and other valuable consideration paid to me by

C.M. Products Limited

a Corporation of Hong Kong, having its principal place of business at 5/F, Block A, Tung Sing Building, 138-144 Queen's Road East, Wanchai, Hong Kong, China, the receipt of which is hereby acknowledged, do hereby sell, assign and transfer unto said

C.M. Products Limited

its successors and assigns, the entire interest for the United States of America and all foreign countries including all rights of priority under the International Convention for the Protection of Industrial Property in a certain invention or improvement in

DOUBLE ACTION HINGES

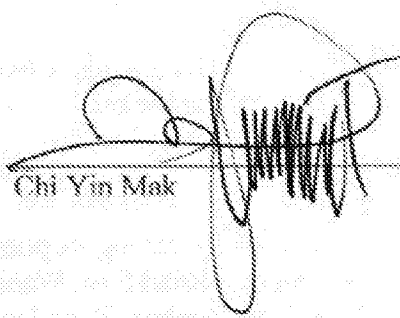
described in the following application:

United States Non-Provisional Patent Application No. 14/991,587, filed January 8, 2016,

in the United States Patent and Trademark Office, and in all Letters Patent of the United States and all foreign countries which may or shall be granted on said invention, or any parts thereof, or on said application, or any divisional, continuing, reissue or other applications based in whole or in part thereon. And I agree, for myself and my executors and administrators, with said Corporation and its successors and assigns but at its or their expense and charges, hereafter to execute all applications, amended specifications, deed or other instrument, and to do all acts necessary or proper to secure the grant of Letters Patent in the United States and in all other countries to said Corporation, with specifications and claims in such form as shall be approved by the counsel of said Corporation and to vest and confirm in said Corporation, its successors and assigns, the legal title to all such patents.

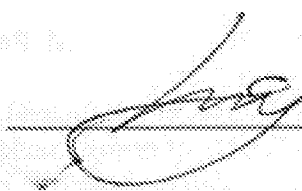
And I do hereby authorize and request the Commissioner of Patents and Trademarks of the United States to issue such Letters Patent as shall be granted upon said application or applications based thereon to said Corporation, its successors and assigns.

3/3/2016
Date


Chi Yin Mak

Witness: MAK YOK KEY

3/3/2016
Date



Witness: YIK KA YIN

3-3-2016

